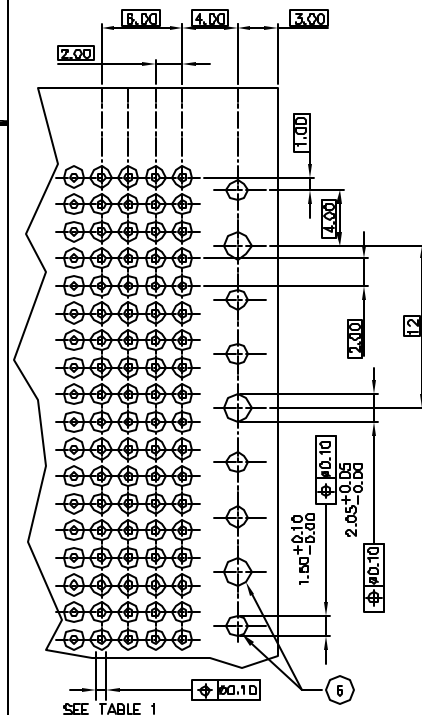
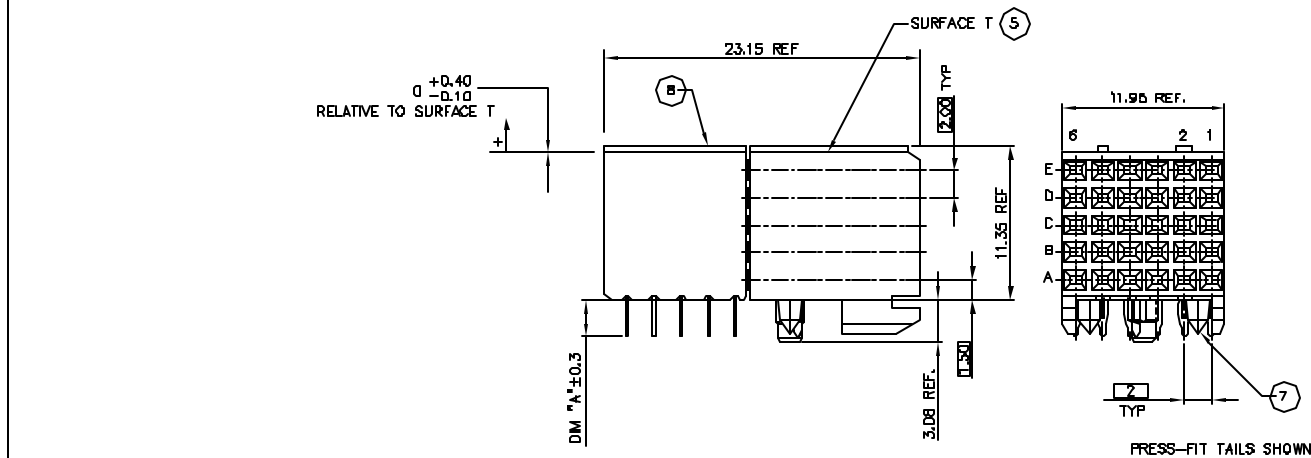


A  
—  
  
C




PRODUCT NUMBER	PEG TYPE	TAIL TYPE	TAIL LGTH. DIM "A"	PCB THICKNESS±0.20	LOADING CONFIGURATION
89047-X02	PRESS	PRESS-FIT	2.73	2.57 MAX	FULLY LOADED
89047-X12	PRESS	PRESS-FIT	3.53	2.57 MAX	

PRODUCT NR:	PLATING CONTACT AREA:	UNDERPLATING
BBD47-1YY	0.8 $\mu$ m GOLD	1.3 $\mu$ m Ni MIN.
BBD47-2YY	2.0 $\mu$ m GOLD	1.3 $\mu$ m Ni MIN.
BBD47-3YY	1.3 $\mu$ m GOLD	1.3 $\mu$ m Ni MIN.
BBD47-9YY	0.8 $\mu$ m GOLD	1.3 $\mu$ m Ni MIN.



RECOMMENDED PC BOARD LAYOUT,  
COMPONENT SIDE.

HOLE DIAMETER AFTER PLATING	0.05-0.80
DRILLED HOLE	0.81-0.80 (0.85 DRILL
COPPER PLATING	0.025 - 0.05
SnPb PLATING	0.005-0.015

mat'l. code NOTE 1			tolerances unless otherwise specified			CUSTOMER COPY		 www.fciconnect.com		
ltr	ecn no	dr	date	linear		projection 	title			
E	H50662	RVI	11/03/95				B SERIES R/A SIGNAL RECEPT ASSY,			
F	H60484	RVI	7/31/96				5 ROW, 1 MOD, PF			
G	V00850	GNV	5/12/00	angles		 MM	product family			code
H	V10165	GNV	7/19/01	dr	C. DAILY		06/18/02	METRAL		213
J	V20558	CGD	4/18/02	engr	M. GRAY		06/18/02	size dwg no		sheet
K	V21076	CGD	6/18/02	chr	M. GRAY	06/18/02	scale	A 89047		1 of 1
L	V03-0722	LP	8/22/03	appd	M. GRAY	06/18/02	1:1			
sheet	revision	L								
index	sheet	1								

ACAD

**PDM: Rev:L**

STATUS:Released

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